



# 250 MHz QAM IF DOWNCONVERTER

# UPC2798GR

## FEATURES

- **RF/LO FREQUENCY RANGE: 30-250 MHz**
- **ON CHIP VCO**
- **LOW DISTORTION AGC AMPLIFIER:**  
-9 dBm IIP<sub>3</sub> @ MIN Gain
- **ON CHIP VIDEO AMP:** 3.0 V<sub>p-p</sub> (V<sub>CC</sub> = 5 V)
- **SMALL 20 PIN SSOP PACKAGE**
- **AVAILABLE ON TAPE AND REEL**

## DESCRIPTION

The UPC2798GR is a Silicon MMIC Downconverter manufactured with the NESAT™III silicon bipolar process. This product consists of an input AGC amplifier, mixer, local oscillator, and video amplifier. It is housed in a small 20 pin SSOP package. The device is designed for use as an IF downconverter for digital CATV settops and cable modems utilizing QAM modulation.

NEC's stringent quality assurance and test procedures ensure the highest reliability and performance.

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, V<sub>CC</sub> = 5 V, unless otherwise specified)

PART NUMBER PACKAGE OUTLINE			UPC2798GR S20		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	TYP	MAX
AGC Amplifier and Mixer Block					
I <sub>CC1</sub>	Circuit Current 1 (no input signal)	mA	17.0	23.0	31.0
f <sub>RF</sub>	RF Input Frequency Range	MHz	30		250
f <sub>OSC</sub>	OSC Frequency Range	MHz	30		250
f <sub>IF</sub>	IF Output Frequency Range	MHz	DC		150
CG <sub>MAX</sub>	Maximum Conversion Gain, V <sub>AGC</sub> = 4.0 V <sup>1</sup>	dB		25	
CG <sub>MIN</sub>	Minimum Conversion Gain, V <sub>AGC</sub> = 1.0 V <sup>1</sup>	dB		-7	
G <sub>CR</sub>	AGC Dynamic Range, V <sub>AGC</sub> = 1.0 to 4.0 V	dB	26	32	38
NF	Noise Figure, SSB, V <sub>AGC</sub> = 4.0 V (MAX Gain) <sup>1</sup>	dB		9	
V <sub>AGC</sub> (H)	AGC Voltage High, at MAX Gain	V	4.0		
V <sub>AGC</sub> (L)	AGC Voltage Low, at MIN Gain	V			1.0
AGC IIP <sub>3</sub>	AGC Input Intercept Point, at MIN Gain	dBm		-9	
Video Amp Block (V <sub>CC</sub> = 5 V, differential)					
I <sub>CC2</sub>	Circuit Current 2 (no input signal)	mA	9.0	12.5	17.0
V <sub>OUT</sub>	Output Voltage, R <sub>L</sub> = 1 kΩ	V <sub>p-p</sub>		3.0	
G <sub>1</sub>	Differential Gain 1, pins G1A and G1B shorted, V <sub>OUT</sub> = 3.0 V <sub>p-p</sub>	V/V		200	
G <sub>2</sub>	Differential Gain 2, pins G1A and G1B open, V <sub>OUT</sub> = 3.0 V <sub>p-p</sub>	V/V		26	
Video Amp Block (V <sub>CC</sub> = 9 V, differential)					
I <sub>CC2</sub>	Circuit Current 2 (no input signal)	mA	17.0	24.0	32.0
V <sub>OUT</sub>	Output Voltage, R <sub>L</sub> = 1 kΩ	V <sub>p-p</sub>		3.0	
G <sub>1</sub>	Differential Gain 1, Pins G1A and G1B shorted, R <sub>L</sub> = 2 kΩ	V/V		385	
G <sub>2</sub>	Differential Gain 2, Pins G1A and G1B open, R <sub>L</sub> = 2 kΩ	V/V		28.5	
Video Amp Block (V <sub>CC</sub> = 5 or 9 V, common)					
BW <sub>G1</sub>	Bandwidth 1, G1	MHz		50	
BW <sub>G2</sub>	Bandwidth 2, G2	MHz		50	
R <sub>IN 1</sub>	Input Resistance 1, G1	kΩ		3.5	
R <sub>IN 2</sub>	Input Resistance 2, G2	kΩ		9.7	
C <sub>IN</sub>	Input Capacitance, C <sub>IN</sub>	pF		1.6	
CMRR	Common Mode Rejection Ratio, V <sub>CM</sub> = 1.0 V <sub>p-p</sub> , f = 100 kHz	dB		80	
PSRR	Power Supply Rejection Ratio	dB		70	
τ <sub>R</sub>	Rise Time	ns		2.6	
τ <sub>D</sub>	Propagation Delay Time	ns		4.4	

Notes:

1. RF = 45 MHz, Lo = 55 MHz, PLo = -10 dBm.

**ABSOLUTE MAXIMUM RATINGS<sup>1</sup>** (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
VCC1	Supply Voltage 1 (Mixer Block)	V	6.0
VCC2	Supply Voltage 2 (Video Amp Block)	V	6.0
PD	Power Dissipation, TA = 85°C <sup>2</sup>	mW	430
TOP	Operating Temperature	°C	-40 to +85
TSTG	Storage Temperature	°C	-55 to +150

SYMBOLS	PARAMETERS	UNITS	RATINGS
VCC1	Supply Voltage 1 (Mixer Block)	V	6.0
VCC2	Supply Voltage 2 (Video Amp Block)	V	11.0
PD	Power Dissipation, TA = 75°C <sup>2</sup>	mW	500
TOP	Operating Temperature	°C	-40 to +75
TSTG	Storage Temperature	°C	-55 to +150

Notes:

1. Operation in excess of any one of these parameters may result in permanent damage.
2. Mounted on a 50 x 50 x 1.6 mm epoxy glass PWB.

**RECOMMENDED OPERATING CONDITIONS**

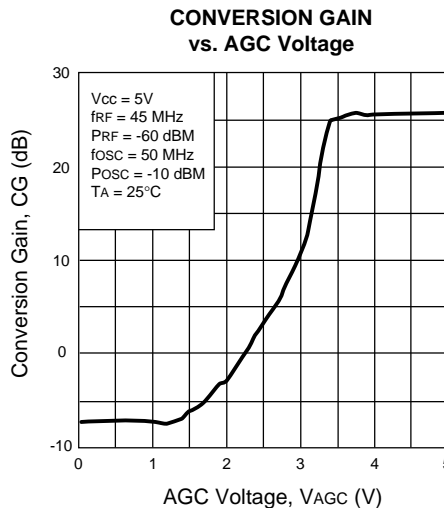
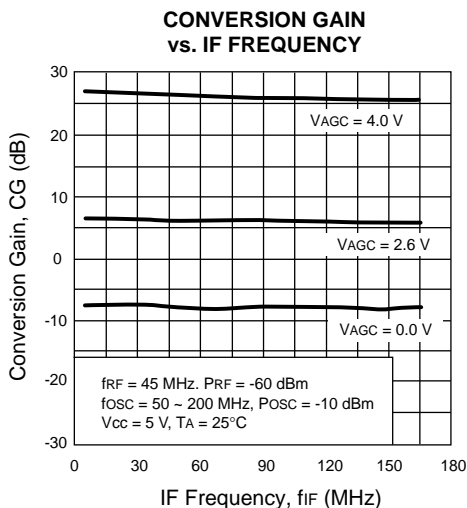
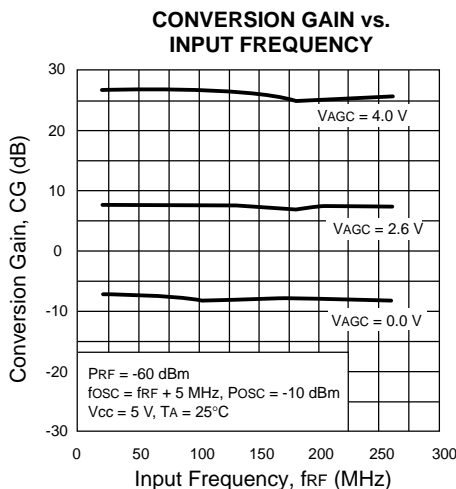
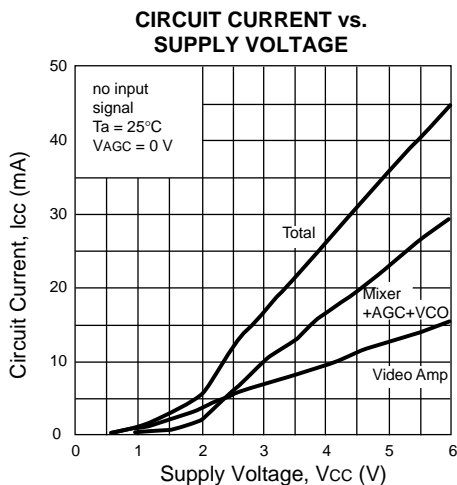
SYMBOL	PARAMETER	UNITS	MIN	TYP	MAX
VCC1	Supply Voltage 1	V	4.5	5.0	5.5
VCC2	Supply Voltage 2	V	4.5	5.0	10.0
TA1	Operating Temp. Range 1*	°C	-40	+25	+85
TA2	Operating Temp. Range 2**	°C	-40	+25	+75

Notes:

\* @ VCC1 = VCC2 = 4.5 to 5.5 V

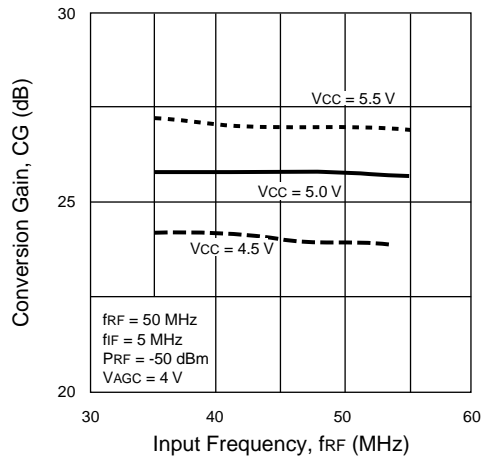
\*\* @ VCC1 = 4.5 to 5.5 V, VCC2 = 4.5 to 10.0 V

**TYPICAL PERFORMANCE CURVES** (TA = 25°C, VCC = 5 V)

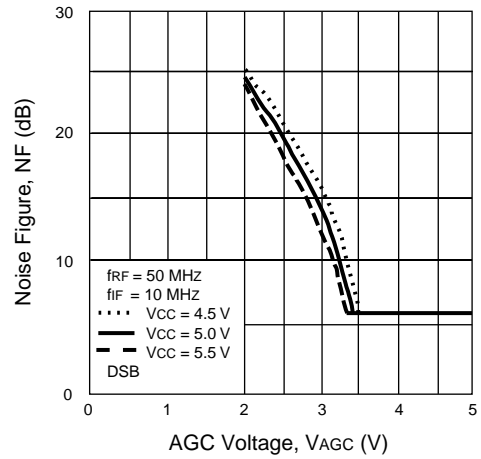


**STANDARD CHARACTERISTICS** (by application circuit example : MIXER block)

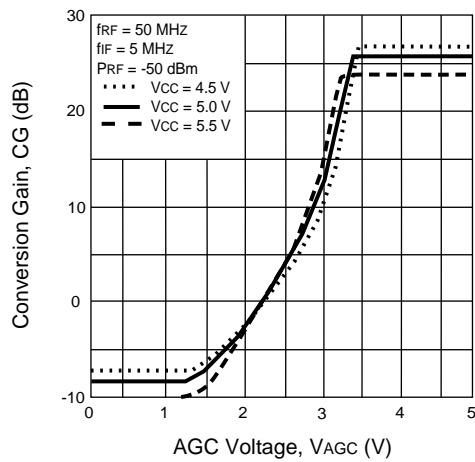
**CONVERSION GAIN vs. INPUT FREQUENCY**



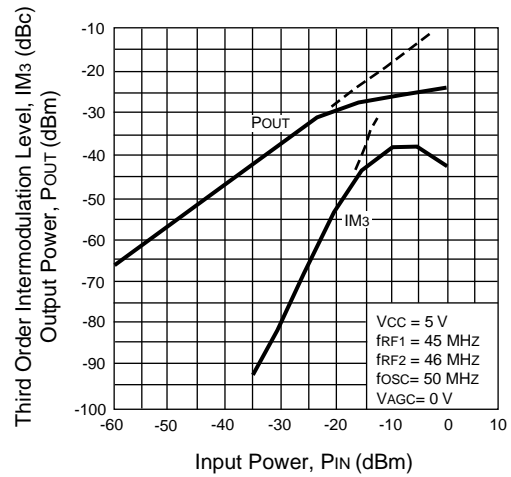
**NOISE FIGURE vs. AGC VOLTAGE**



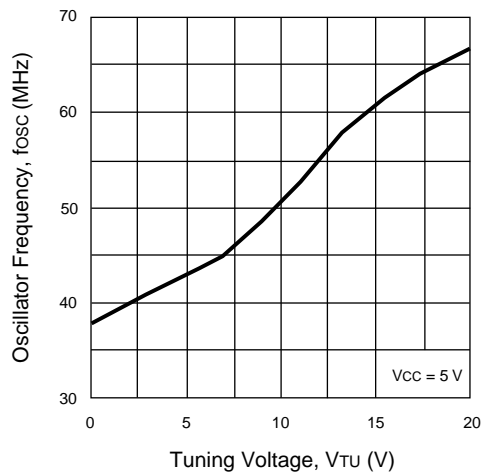
**CONVERSION GAIN vs. AGC VOLTAGE**



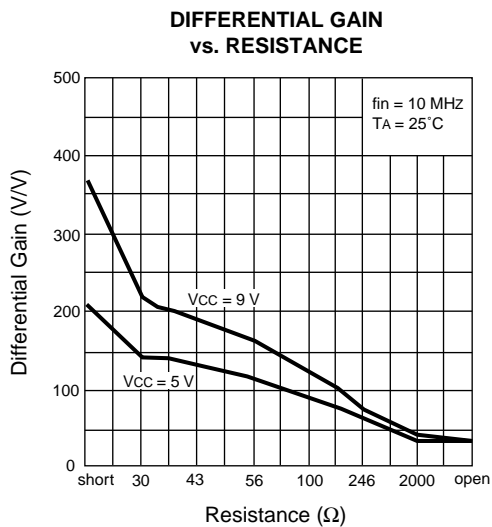
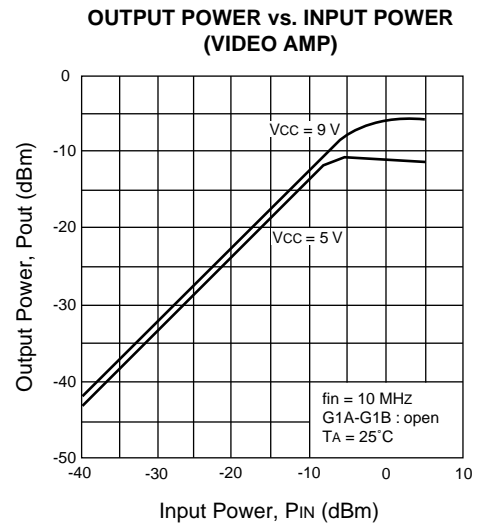
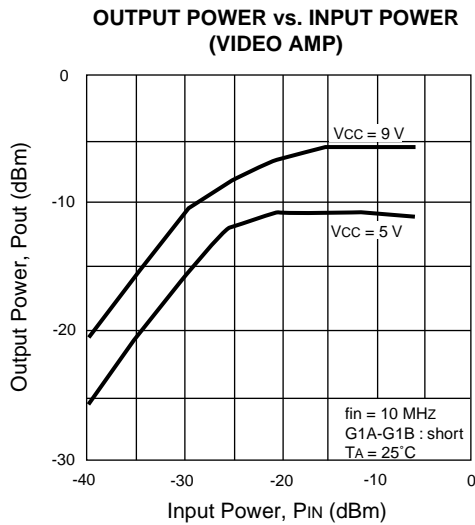
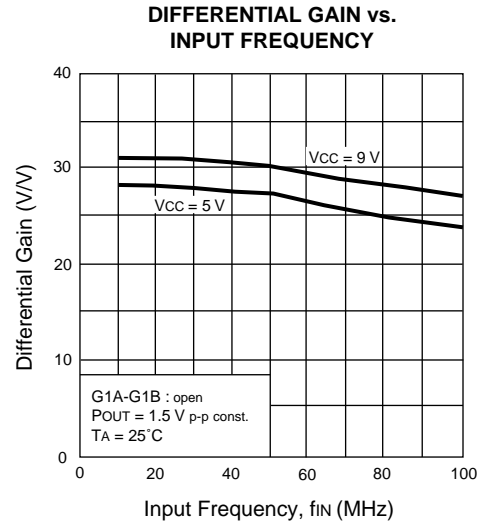
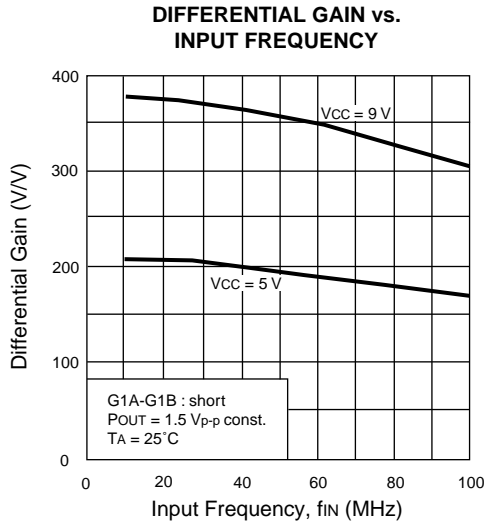
**THIRD ORDER INTERMODULATION LEVEL AND OUTPUT POWER vs. INPUT POWER**



**OSCILLATOR FREQUENCY vs. TUNING VOLTAGE**

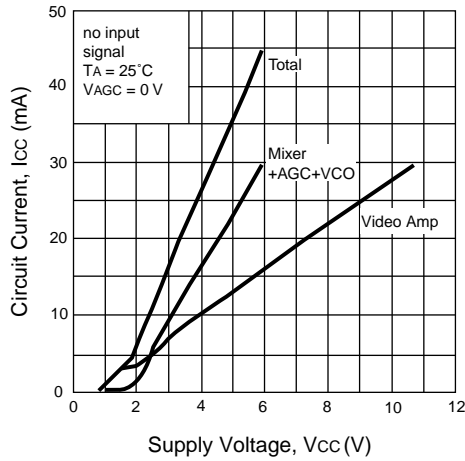


**STANDARD CHARACTERISTICS** (by measurement circuit 2)

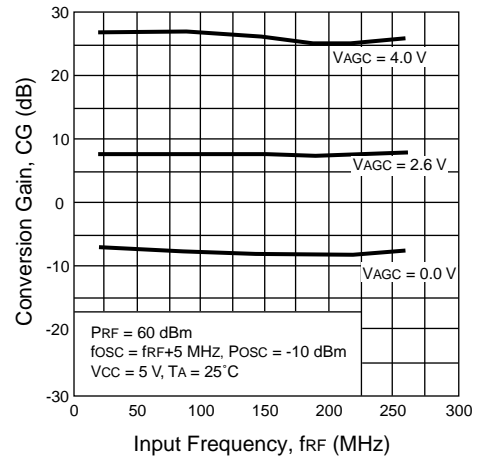


**TYPICAL CHARACTERISTICS** (by measurement circuit 1)

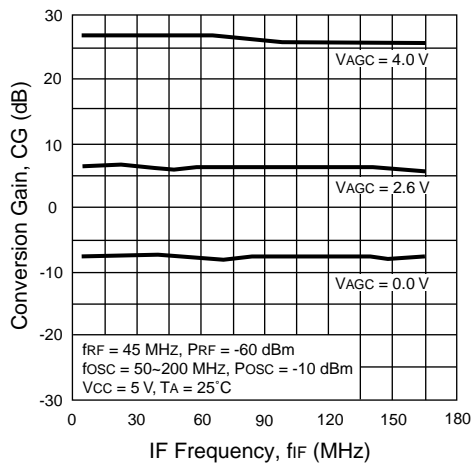
**CIRCUIT CURRENT vs. SUPPLY VOLTAGE**



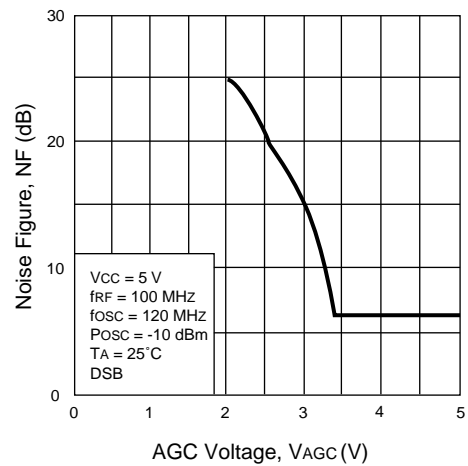
**CONVERSION GAIN vs. INPUT FREQUENCY**



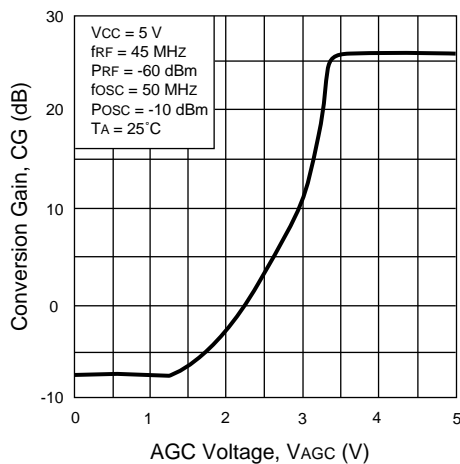
**CONVERSION GAIN vs. IF FREQUENCY**



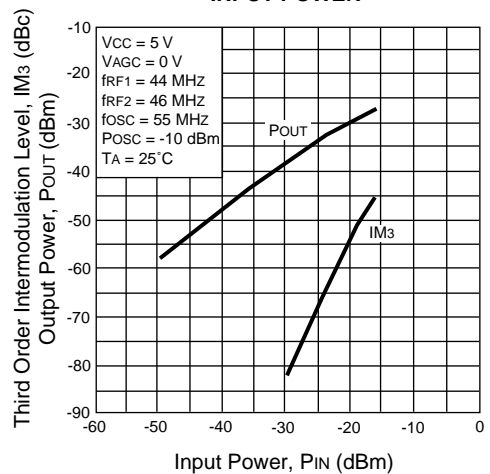
**NOISE FIGURE vs. AGC VOLTAGE**



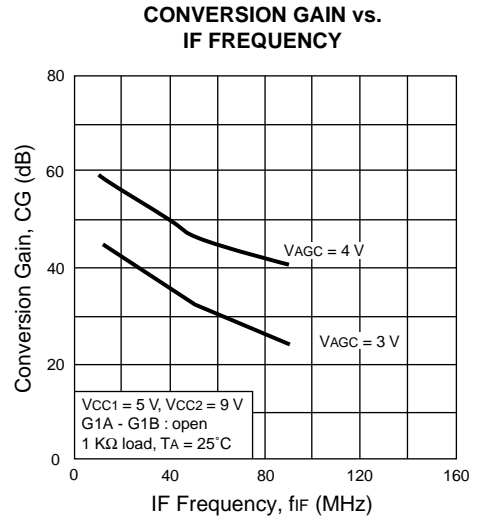
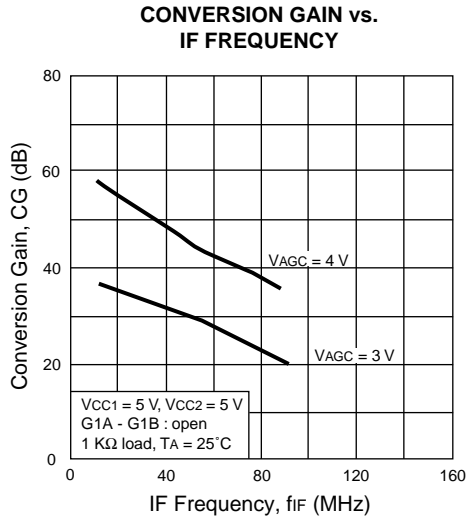
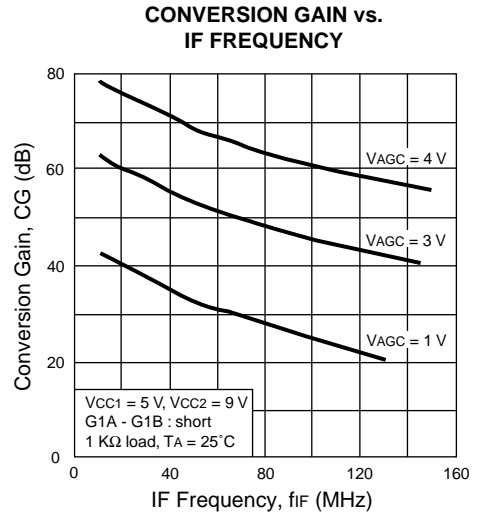
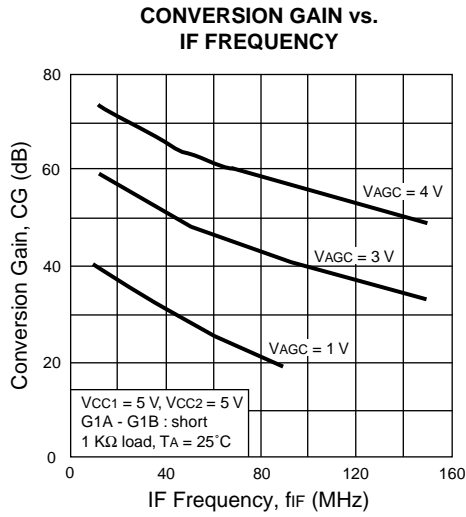
**CONVERSION GAIN vs. AGC VOLTAGE**



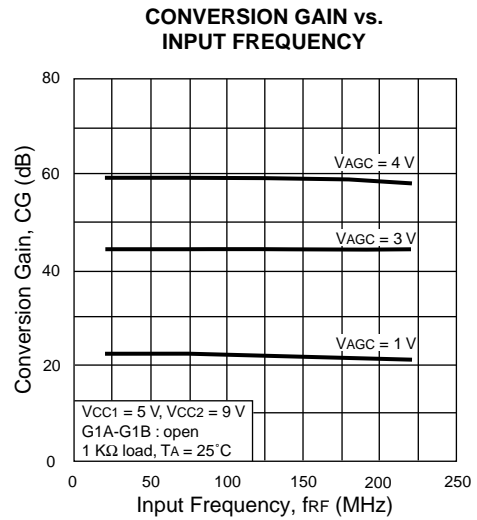
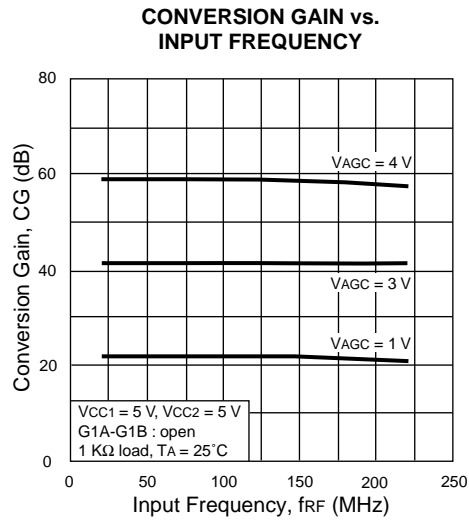
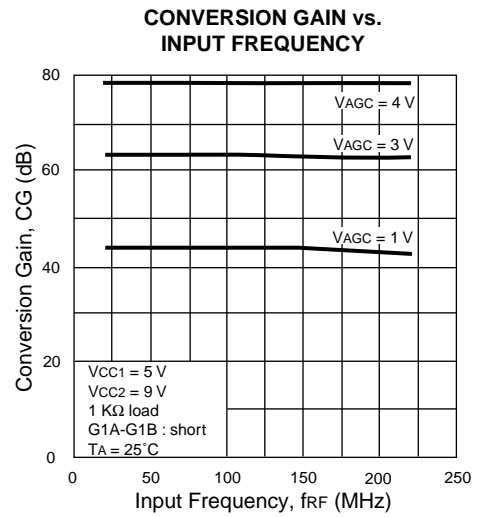
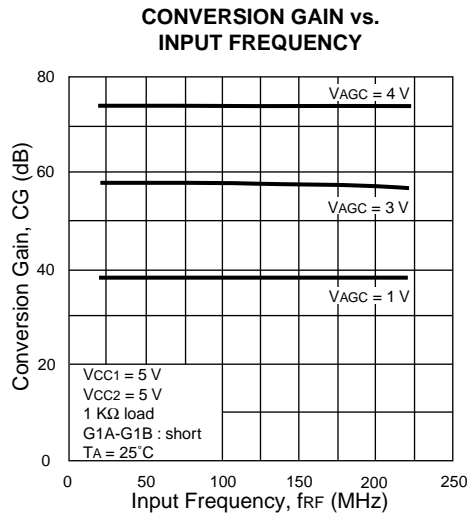
**THIRD ORDER INTERMODULATION LEVEL AND OUTPUT POWER vs. INPUT POWER**



**TYPICAL CHARACTERISTICS** (by measurement circuit 3,  $f_{RF} = 45$  MHz,  $P_{RF} = -60$  dBm,  $P_{osc} = -10$  dBm)



**TYPICAL CHARACTERISTICS** (by measurement circuit 3, PRF = -60 dBm, fosc = frF + 10 MHz, Posc = -10 dBm)



**PIN FUNCTIONS**

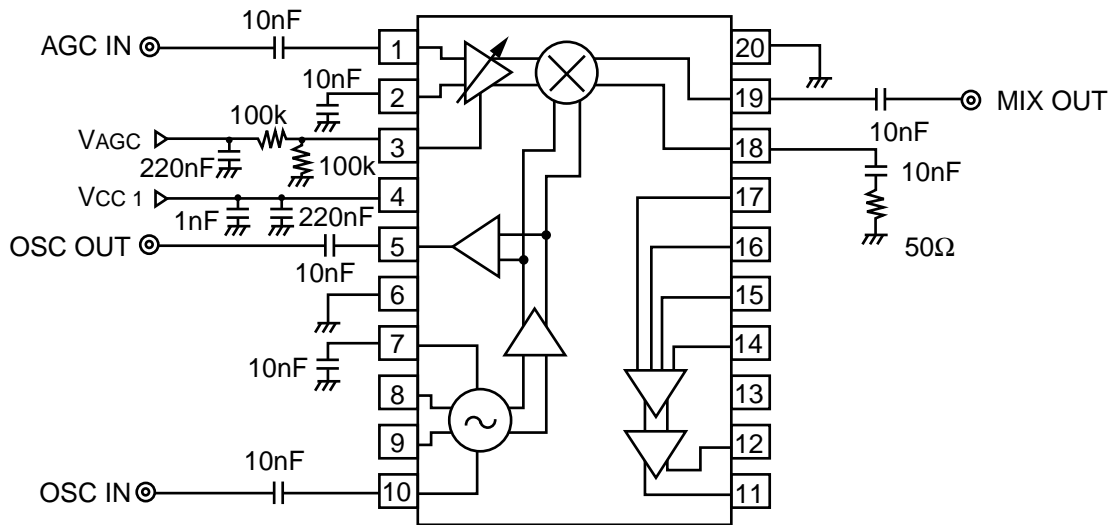
Pin No.	Pin Name	Pin Voltage Typ. (V)	Function and Explanation	Equivalent Circuit
1	AGC IN1	1.5	RF input pins. Pins 1 and 2 are each base inputs to a differential amplifier. In the case of a single-ended input, bypass the unused pin to ground through a capacitor.	
2	AGC IN2	1.5		
3	VAGC	0~5	Gain control pin of the mixer input amplifier. VAGC up = gain up. It is recommended to use a 100k $\Omega$ voltage divider at this pin.	
4	Vcc1	5.0	Supply voltage pin for the downconverter block. This pin should be connected with a bypass capacitor (e.g., 1000 pF) to minimize ground impedance.	
5	OSC OUT	4.0	Output pin for the internal oscillator. This pin may be connected to the input of a PLL synthesizer.	
6	GND	0.0	Ground pin. This pin must be connected to system ground. Form ground pattern as wide as possible to minimize ground impedance.	
7	OSC B2	2.4	Input pins for the internal oscillator. The internal oscillator consists of a balanced amplifier.	
8	OSC C1	4.6		
9	OSC C2	4.6		
10	OSC B1	2.4		

## PIN FUNCTIONS

Pin No.	Pin Name	Pin Voltage Typ. (V) ( ) is value at $V_{CC} = 9V$	Function and Explanation	Equivalent Circuit
11	OUT2	2.5 (4.7)	Output pins for the video amplifier. With $R_L = 1k\Omega$ , the differential output voltage is 3 Vp-p. OUT1 and INA are in phase. OUT2 and INB are in phase. In the case of a single-ended output, bypass the unused pin to ground through a capacitor.	
12	OUT1	2.5 (4.7)		
13	Vcc2	5-9	Supply voltage pin for the video amplifier block. This pin should be connected with a bypass capacitor (e.g., 1000 pF) to minimize ground impedance.	
14	INB	2.5 (4.1)	Input pins for the video amplifier. These pins have high impedance. In the case of a single-ended input, bypass the unused pin to ground through a capacitor.	
15	INA	2.5 (4.1)		
16	G1B	1.7 (3.3)	Gain control pins for the video amplifier. The gain may be adjusted by varying the value of the resistor between pins 16 and 17. Maximum gain = short; Minimum gain = open.	
17	G1A	1.7 (3.3)		
18	MIX OUT1	3.7	Output pins for the downconverter. These are emitter follower outputs which feature low impedance. In the case of a single-ended output, bypass the unused pin to ground through a capacitor.	
19	MIX OUT2	3.7		
20	GND	0.0	Ground pin. This pin must be connected to system ground. Form ground pattern as wide as possible to minimize ground impedance.	

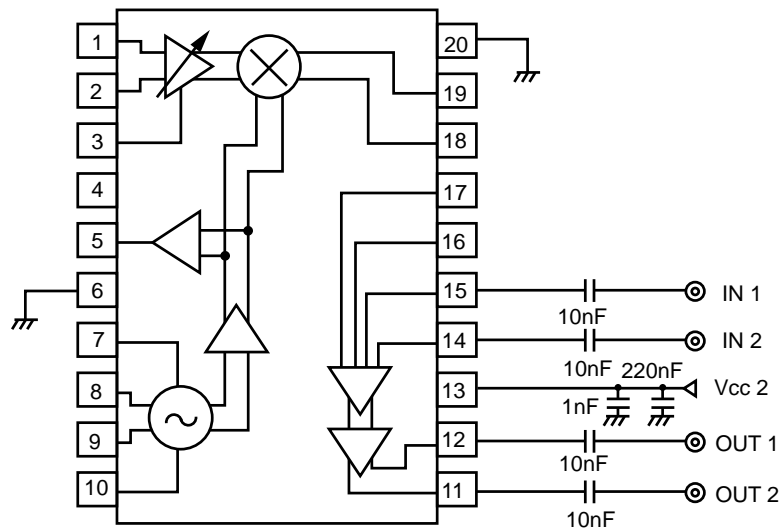
MEASUREMENT CIRCUIT 1

AGC & MIXER BLOCK



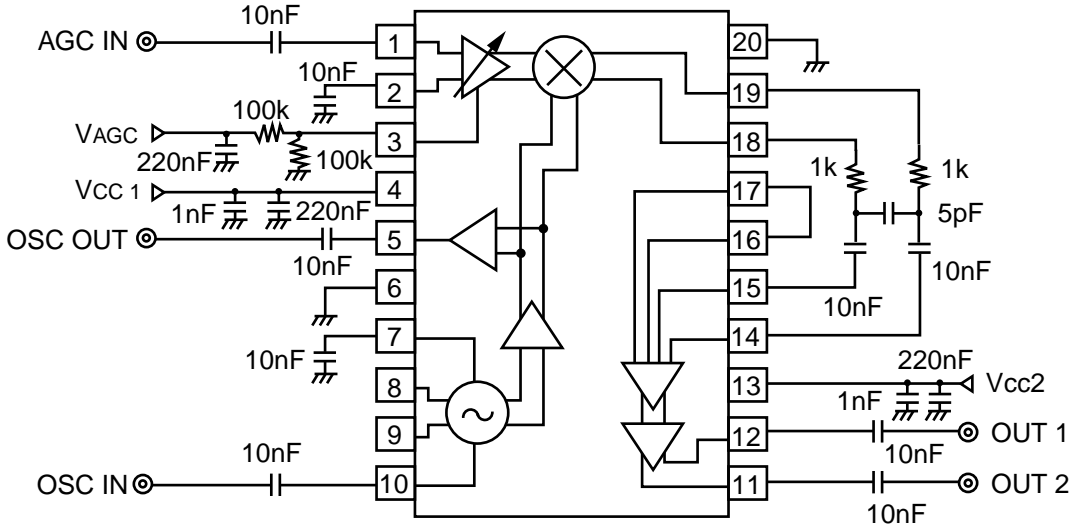
MEASUREMENT CIRCUIT 2

VIDEO AMP BLOCK

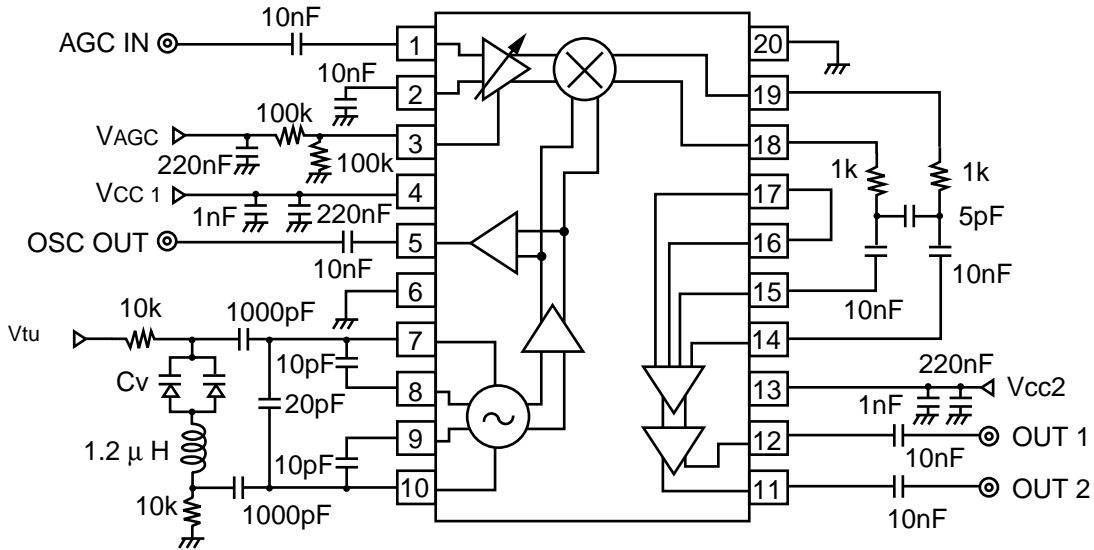


MEASUREMENT CIRCUIT 3

TOTAL BLOCK



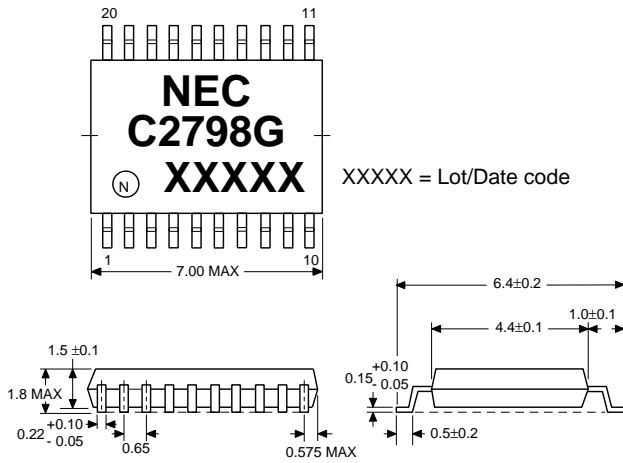
APPLICATION CIRCUIT EXAMPLE



Cv: ISV209

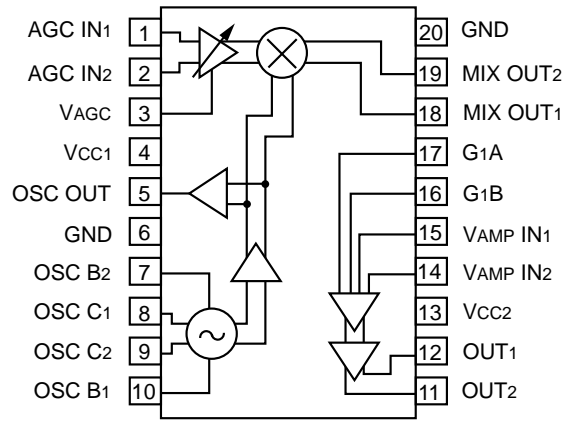
**OUTLINE DIMENSIONS** (Units in mm)

**PACKAGE OUTLINE SSOP 20**



All dimensions are typical unless specified otherwise.

**INTERNAL BLOCK DIAGRAM**



**ORDERING INFORMATION**

PART NUMBER	QUANTITY
UPC2798GR-E1	2500/Reel

Notes:

Embossed tape, 12 mm wide.

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